

REPETITIVE AVALANCHE AND dv/dt RATED HEXFET®TRANSISTORS THRU-HOLE (TO-205AF)

JANTX2N6800 JANTXV2N6800 JANTXV2N6800 REF:MIL-PRF-19500/557 400V, N-CHANNEL

Product Summary

Part Number	BVDSS	RDS(on)	ΙD	
IRFF330	400V	1.0Ω	3.0A	

The HEXFET[®] technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high transconductance.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of parelleling and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.



Features:

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- Hermetically Sealed
- Simple Drive Requirements
- Ease of Paralleling
- ESD Rating: Class 1C per MIL-STD-750, Method 1020

Absolute Maximum Ratings

	Parameter		Units
ID @ VGS = 10V, TC = 25°C Continuous Drain Current		3.0	
ID @ VGS = 10V, TC = 100°C	Continuous Drain Current	2.0	Α
IDM	Pulsed Drain Current ①	12	
P _D @ T _C = 25°C	Max. Power Dissipation	25	W
	Linear Derating Factor	0.20	W/°C
V _G S	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	191	mJ
IAR	Avalanche Current ①	3.0	Α
EAR	Repetitive Avalanche Energy ①	2.5	mJ
dv/dt	Peak Diode Recovery dv/dt 3	4.0	V/ns
TJ	Operating Junction	-55 to 150	
TSTG Storage Temperature Range			°C
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10s)	
	Weight	0.98 (typical)	g

For footnotes refer to the last page

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	400	_	_	V	VGS = 0V, ID = 1.0mA
ΔBV _{DSS} /ΔT _J	Temperature Coefficient of Breakdown Voltage	_	0.37	_	V/°C	Reference to 25°C, I _D = 1.0mA
RDS(on)	Static Drain-to-Source On-State	_	_	1.0		Vgs = 10V, ID = 2.0A 4
, ,	Resistance	_	_	1.15	Ω	Vgs = 10V, ID = 3.0A 4
VGS(th)	Gate Threshold Voltage	2.0	_	4.0	V	V _{DS} = V _{GS} , I _D = 250μA
gfs	Forward Transconductance	2.0	_	_	S	VDS = 15V, IDS = 2.0A 4
IDSS	Zero Gate Voltage Drain Current	_	_	25		V _{DS} = 320V, V _{GS} = 0V
		_	_	250	μA	V _{DS} = 320V
						VGS = 0V, TJ = 125°C
IGSS	Gate-to-Source Leakage Forward	_	_	100		VGS = 20V
IGSS	Gate-to-Source Leakage Reverse	_	_	-100	nA	VGS = -20V
Qg	Total Gate Charge	19.1	_	33		VGS =10V, ID = 3.0A
Qgs	Gate-to-Source Charge	1.0	_	5.8	nC	$V_{DS} = 200V$
Q _{gd}	Gate-to-Drain ('Miller') Charge	6.7	_	19.9		
^t d(on)	Turn-On Delay Time	_	_	30		$V_{DD} = 200V, I_{D} = 3.0A,$
tr	Rise Time	_	_	35	ns	$V_{GS} = 10V$, $R_{G} = 7.5\Omega$
^t d(off)	Turn-Off Delay Time	_	_	55	115	
tf	Fall Time		_	35		
L _{S+} L _D	Total Inductance	_	7.0	_	nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
Ciss	Input Capacitance	_	620	_		VGS = 0V, VDS = 25V
Coss	Output Capacitance	_	200	_	pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	_	75	_		

Source-Drain Diode Ratings and Characteristics

	Parameter		Min	Тур	Max	Units	Test Conditions
Is	Continuous Source Current (Body Diode)		_	_	3.0	Α	
ISM	Pulse Source Current (Body Diode) ①		_	_	12		
VSD	Diode Forward Voltage		_	_	1.4	V	$T_j = 25^{\circ}C$, $I_S = 3.0A$, $V_{GS} = 0V$ ④
trr	Reverse Recovery Time		_	_	700	ns	T_j = 25°C, I_F = 3.0A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge		_	_	6.2	μC	V _{DD} ≤ 50V ④
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.					

Thermal Resistance

	Parameter	Min	Тур	Max	Units	Test Conditions
R _{th} JC	Junction-to-Case	_	_	5.0	°C/W	
RthJA	Junction-to-Ambient	_	_	175	C/VV	Typical socket mount.

Note: Corresponding Spice and Saber models are available on International Rectifier website.

For footnotes refer to the last page

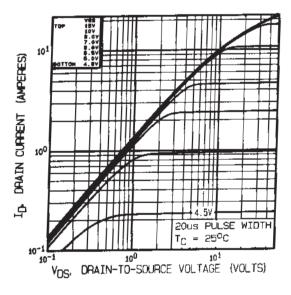


Fig 1. Typical Output Characteristics

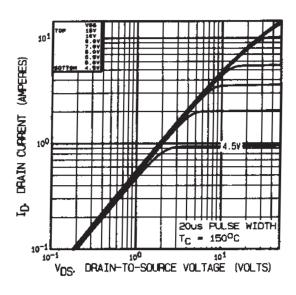


Fig 2. Typical Output Characteristics

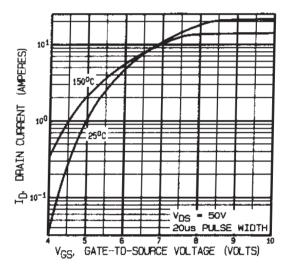


Fig 3. Typical Transfer Characteristics

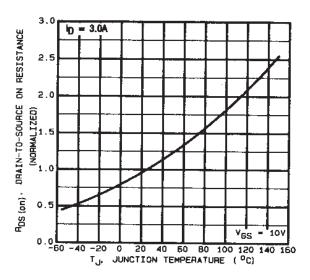


Fig 4. Normalized On-Resistance Vs. Temperature

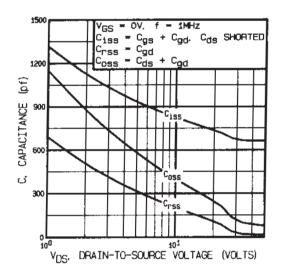


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

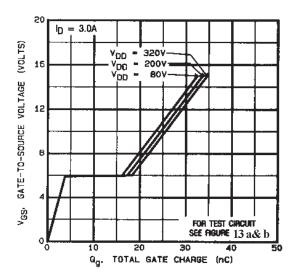


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

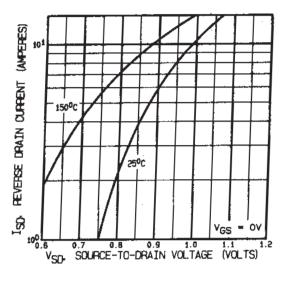


Fig7. Typical Source-Drain Diode Forward Voltage

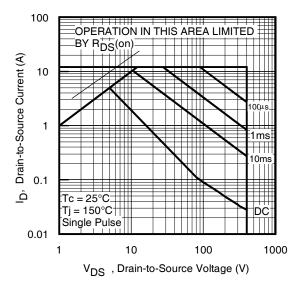


Fig8. Maximum Safe Operating Area

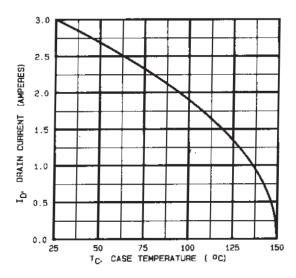


Fig 9. Maximum Drain Current Vs. Case Temperature

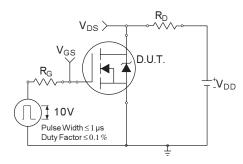


Fig 10a. Switching Time Test Circuit

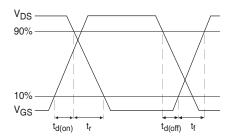


Fig 10b. Switching Time Waveforms

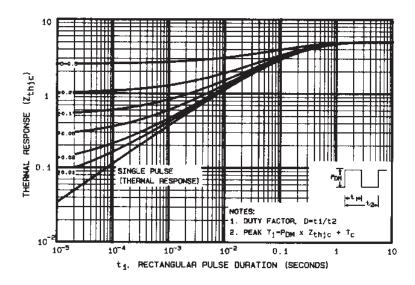


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

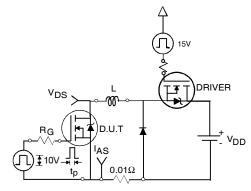


Fig 12a. Unclamped Inductive Test Circuit

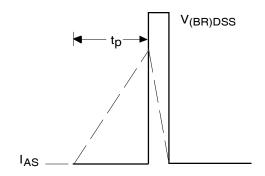


Fig 12b. Unclamped Inductive Waveforms

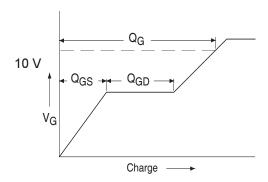


Fig 13a. Basic Gate Charge Waveform

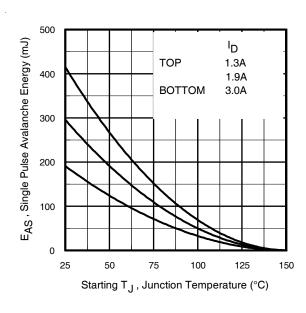


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

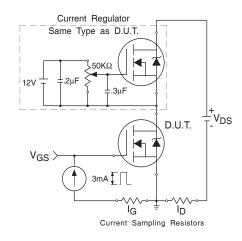
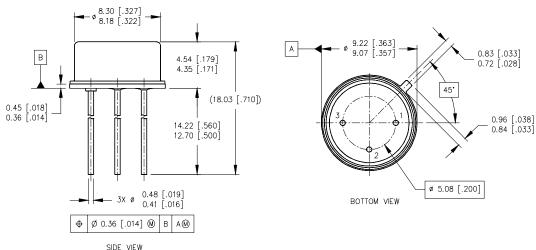


Fig 13b. Gate Charge Test Circuit

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$ V_{DD} = 50V, Starting T_J = 25°C, L = 42.5mH Peak I_L = 3.0A, V_{GS} =10V, R_G = 25 Ω
- ® I_{SD} \leq 3.0A, di/dt \leq 90A/ μ s, V_{DD} \leq 400V, T_J \leq 150°C, Suggested RG =7.5 Ω
- ④ Pulse width ≤ 300 μ s; Duty Cycle ≤ 2%

Case Outline and Dimensions —TO-205AF (TO-39)



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME 14.5M-1994.
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 3. CONTROLLING DIMENSION: INCH.
- 4. CONFORMS TO JEDEC OUTLINE TO-205AF (TO-39).

LEGEND

- 1- SOURCE
- 2- GATE
- 3- DRAIN

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